LM118, LM218, LM318 FAST GENERAL-PURPOSE OPERATIONAL AMPLIFIERS

The LM118 and LM218 are obsolete and are no longer supplied.

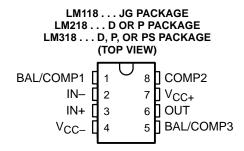
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- Small Signal Bandwidth . . . 15 MHz Typ
- Slew Rate . . . 50 V/μs Min
- Bias Current . . . 250 nA Max (LM118, LM218)
- Supply Voltage Range . . . ±5 V to ±20 V
- Internal Frequency Compensation
- Input and Output Overload Protection
- Same Pin Assignments as General-Purpose Operational Amplifiers

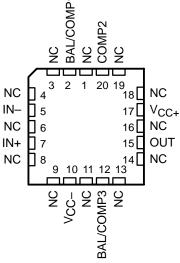
description/ordering information

The LM118, LM218, and LM318 are precision, fast operational amplifiers designed for applications requiring wide bandwidth and high slew rate. They feature a factor-of-ten increase in speed over general-purpose devices without sacrificing dc performance.

These operational amplifiers have internal unity-gain frequency compensation. considerably simplifies their application because no external components are necessary for operation. However, unlike most internally compensated amplifiers, external frequency compensation may be added for optimum performance. For inverting applications, feed-forward compensation boosts the slew rate to over 150 V/µs and almost double the bandwidth. Overcompensation can be used with the amplifier for greater stability when maximum bandwidth is not needed. Further, a single capacitor can be added to reduce the settling time for 0.1% error band to under 1 μs.



LM118 ... FK PACKAGE (TOP VIEW)



NC - No internal connection

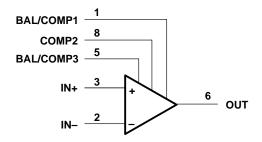
The high speed and fast settling time of these operational amplifiers make them useful in A/D converters, oscillators, active filters, sample-and-hold circuits, and general-purpose amplifiers.

ORDERING INFORMATION

TA	V _{IO} max AT 25°C	PACK	AGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
0°C to 70°C	10 mV	PDIP (P)	Tube of 50	LM318P	LM318P	
		SOIC (D)	Tube of 75	LM318D	1.0404.0	
			Reel of 2500	LM318DR	LM318	
		SOP (PS)	Reel of 2000	LM318PSR	LM18	

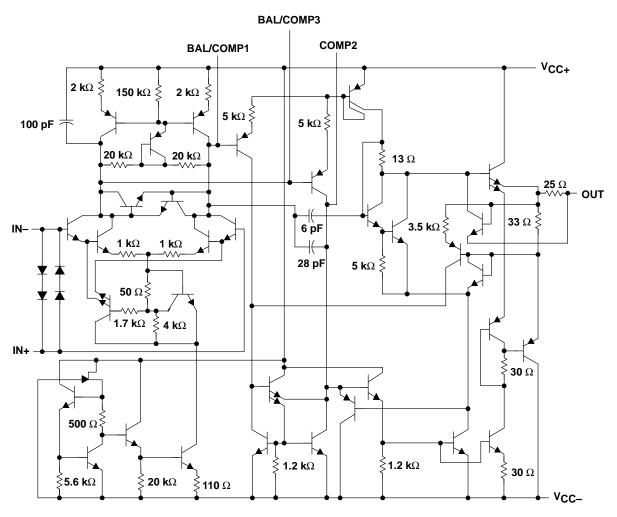
[†] Package drawings, standard packing quantities, thermal data, symboliztion, and PCB design guidelines are available at www.ti.com/sc/package.

symbol



Pin numbers shown are for the D, JG, P, and PS packages.

schematic



Component values shown are nominal.



LM118, LM218, LM318 FAST GENERAL-PURPOSE OPERATIONAL AMPLIFIERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage: V _{CC+} (see Note 1)	20 V
V _{CC} – (see Note 1)	–20 V
Input voltage, V _I (either input, see Notes 1 and 2)	±15 V
Differential input current, V _{ID} (see Note 3)	±10 V
Duration of output short circuit (see Note 4)	Unlimited
Operating virtual junction temperature, T _J	
Package thermal impedance, θ _{JA} (see Notes 5 and 6): D package	97°C/W
P package	85°C/W
PS package	95°C/W
Package thermal impedance, θ _{JC} (see Notes 7 and 8): FK package	5.61°C/W
JG package	14.5°C/W
Case temperature for 60 seconds: FK package	260°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: JG package	300°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: D, P, PS, or PW package	260°C
Storage temperature range, T _{Stq}	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, unless otherwise noted, are with respect to the midpoint between V_{CC+} and V_{CC-}
 - 2. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 - 3. The inputs are shunted with two opposite-facing base-emitter diodes for overvoltage protection. Therefore, excessive current flows if a different input voltage in excess of approximately 1 V is applied between the inputs unless some limiting resistance is used.
 - 4. The output can be shorted to ground or either power supply. For the LM118 and LM218 only, the unlimited duration of the short circuit applies at (or below) 85°C case temperature or 75°C free-air temperature.
 - 5. Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperautre is P_D = (T_J(max) T_A)/θ_{JA}. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 6. The package thermal impedance is calculated in accordance with JESD 51-7.
 - 7. Maximum power dissipation is a function of $T_J(max)$, θ_{JC} , and T_C . The maximum allowable power dissipation at any allowable ambient temperautre is $P_D = (T_J(max) T_C)/\theta_{JC}$. Operating at the absolute maximum T_J of 150°C can affect reliability.
 - 8. The package thermal impedance is calculated in accordance with MIL-STD-883.



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electrical characteristics at specified free-air temperature (see Note 5)

PARAMETER		TEST CONDITIONS [†]	T _A ‡	LM118, LM218		LM318				
				MIN	TYP	MAX	MIN	TYP	MAX	UNIT
	land that all a	., .	25°C		2	4		4	10	>/
VIO	Input offset voltage	VO = 0	Full range			6			15	mV
lio	Input offset current	V _O = 0	25°C		6	50		30	200	nA
			Full range			100			300	
I _{IB}	Input bias current	V _O = 0	25°C		120	250		150	500	- ^
			Full range			500			750	nA
VICR	Common-mode input voltage range	$V_{CC\pm} = \pm 15 \text{ V}$	Full range	±11.5			±11.5			V
V _{OM}	Maximum peak output voltage swing	$V_{CC\pm} = \pm 15 \text{ V},$ $R_L = 2 \text{ k}\Omega$	Full range	±12	±13		±12	±13		V
A _{VD}	Large-signal differential voltage amplification	$V_{CC\pm} = \pm 15 \text{ V},$ $V_{O} = \pm 10 \text{ V},$ $R_{L} \ge 2 \text{ k}\Omega$	25°C	50	200		25	200		V/mV
			Full range	25			20			
B ₁	Unity-gain bandwidth	$V_{CC\pm} = \pm 15 \text{ V}$	25°C		15			15		MHz
rį	Input resistance		25°C	1*	3		0.5	3		$M\Omega$
CMRR	Common-mode rejection ratio	V _{IC} = V _{ICR} min	Full range	80	100		70	100		dB
ksvr	Supply-voltage rejection ratio (ΔV _{CC} /ΔV _{IO})		Full range	70	80		65	80		dB
ICC	Supply current	$V_O = 0$, No load	25°C		5	8		5	10	mA

^{*} On products compliant to MIL-STD-883, Class B, this parameter is not production tested.

operating characteristics, $V_{CC\pm}$ = ±15 V, T_A = 25°C

PARAMETER		TEST CONDITIONS				TYP	MAX	UNIT
SR	Slew rate at unity gain	$\Delta V_{I} = 10 V$,	C _L = 100 pF,	See Figure 1	50*	70		V/μs

^{*} On products compliant to MIL-STD-883, Class B, this parameter is not production tested.

PARAMETER MEASUREMENT INFORMATION

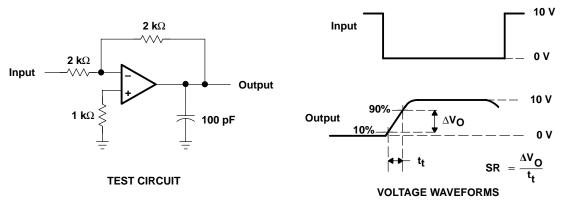


Figure 1. Slew Rate



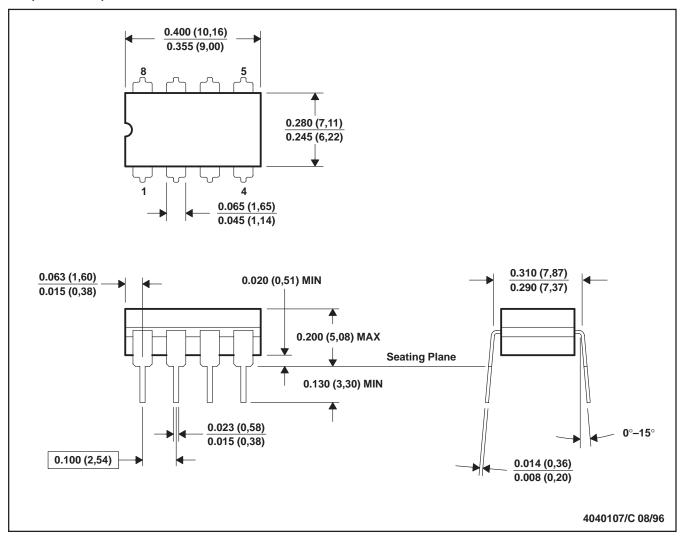
[†] All characteristics are measured under open-loop conditions with common-mode input voltage, unless otherwise specified.

[‡] Full range for LM118 is -55°C to 125°C, full range for LM218 is -25°C to 85°C, and full range for LM318 is 0°C to 70°C.

NOTE 9: Unless otherwise noted, $V_{CC} = \pm 5 \text{ V}$ to $\pm 20 \text{ V}$. All typical values are at $V_{CC\pm} = \pm 15 \text{ V}$ and $T_A = 25^{\circ}\text{C}$.

JG (R-GDIP-T8)

CERAMIC DUAL-IN-LINE



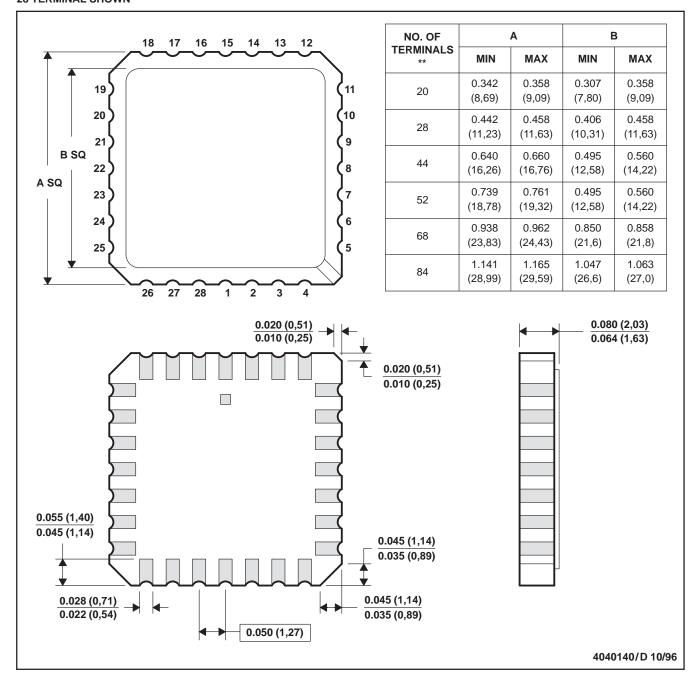
NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification.
- E. Falls within MIL STD 1835 GDIP1-T8

FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



- NOTES: A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a metal lid.
 - D. The terminals are gold plated.
 - E. Falls within JEDEC MS-004



P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

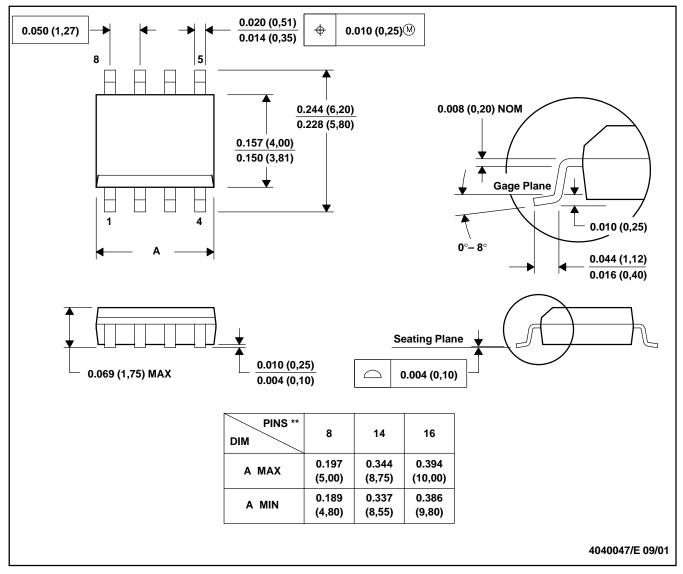
- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

D (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

8 PINS SHOWN

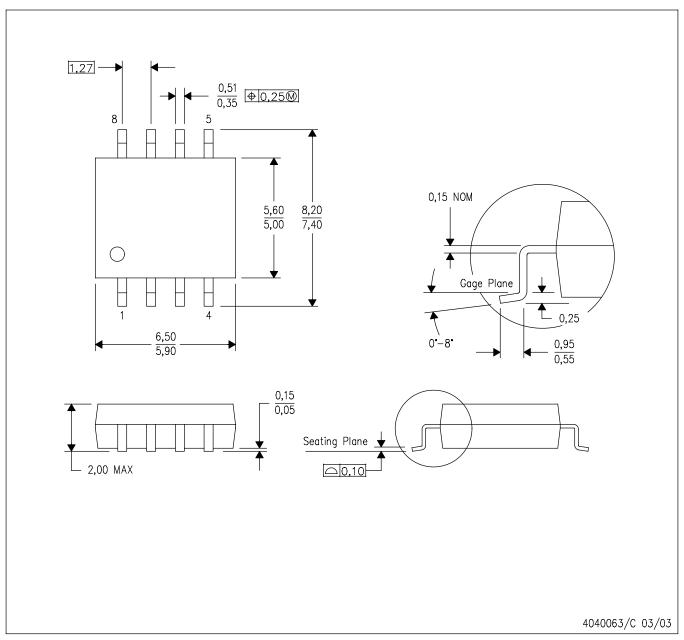


NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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